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## N-Channel SuperFET<sup>®</sup> II MOSFET

600 V, 28 A, 130 mΩ

### Features

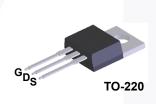
- 650 V @ T<sub>J</sub> = 150°C
- Typ. R<sub>DS(on)</sub> = 112 mΩ
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 54 nC)
- Low Effective Output Capacitance (Typ. C<sub>oss(eff.)</sub> = 240 pF)
- 100% Avalanche Tested
- RoHS Compliant

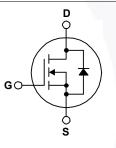
### Applications

- Telecom / Sever Power Supplies
- Industrial Power Supplies

## Description

SuperFET<sup>®</sup> II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SuperFET II MOSFET is suitable for various AC/DC power conversion for system miniaturization and higher efficiency.





### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

Symbol		FCP130N60	Unit			
V <sub>DSS</sub>	Drain to Source Voltage	600	V			
V <sub>GSS</sub>	Cata ta Cauraa Maltaga	- DC		±20	- V	
	Gate to Source Voltage	- AC	±30			
I <sub>D</sub>	Drain Current	- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)		28	^	
	Drain Current	- Continuous (T <sub>C</sub> = 100 <sup>o</sup> C)		18	A	
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	84	А	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)			720	mJ	
I <sub>AR</sub>	Avalanche Current (Note 1)			6	Α	
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)			2.78	mJ	
dv/dt	MOSFET dv/dt			100	V/ns	
	Peak Diode Recovery dv/dt (Note 3)			20		
P <sub>D</sub>	Dawan Dissingtion	(T <sub>C</sub> = 25 <sup>o</sup> C)		278	W	
	Power Dissipation	- Derate Above 25°C		2.2	W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

#### **Thermal Characteristics**

Symbol	Parameter	FCP130N60	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.45	°C/W	
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient, Max.	40	°C/VV	

Part Nur	mber	Top Mark	Package	Packing Method Reel Size		Тар	e Width	Qua	ntity
FCP130N60		FCP130N60	TO-220	Tube	N/A	N/A		50 units	
Electrica	l Char	acteristics T <sub>C</sub> =	= 25°C unless	otherwise noted.		- <b>I</b>			
Symbol	Parameter			Test Conditions		Min.	Тур.	Max.	Unit
Off Charac	teristic	S							
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage		/oltage	$V_{GS} = 0 V, I_D = 10 mA, T_J = 25^{\circ}C$		600 650		-	v
ΔBV <sub>DSS</sub> / ΔΤ.Ι	Breakdown Voltage Temperature		ture	$V_{GS} = 0 \text{ V}, I_D = 10 \text{ mA}, T_J = 150^{\circ}\text{C}$ $I_D = 10 \text{ mA}, \text{ Referenced to } 25^{\circ}\text{C}$		-	0.67	-	V/ºC
/ Δ1	Coencient			V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V		-	-	1	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current		rent	$V_{\rm DS} = 480 \text{ V}, V_{\rm GS} = 0 \text{ V}, T_{\rm C} = 125^{\circ}\text{C}$		-	1.3	-	μA
I <sub>GSS</sub>	Gate to	Body Leakage Curre	nt	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$		-	-	±100	nA
On Charac	teristic	s							
V <sub>GS(th)</sub>	Gate Th	nreshold Voltage		V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250	μA	2.5	-	3.5	V
R <sub>DS(on)</sub>		)rain to Source On Re	sistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 14 \text{ A}$		-	112	130	mΩ
9FS	Forward	d Transconductance		$V_{DS} = 20 \text{ V}, I_D = 14 \text{ A}$		-	26	-	S
Dynamic C	haracte	eristics							
C <sub>iss</sub>	•	apacitance		V <sub>DS</sub> = 380 V, V <sub>GS</sub> = 0 V, f = 1 MHz		-	2700	3590	pF
C <sub>oss</sub>		Capacitance				-	65	85	pF
C <sub>rss</sub>		e Transfer Capacitanc				-	2.85	-	pF
C <sub>oss(eff.)</sub>	Effective Output Capacitance $V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$			-	240	-	pF		
Q <sub>g(tot)</sub>		ate Charge at 10V		V <sub>DS</sub> = 380 V, I <sub>D</sub> = 14 A, V <sub>GS</sub> = 10 V (Note 4)		-	54	70	nC
Q <sub>gs</sub>		Source Gate Charge				-	12	-	nC
Q <sub>gd</sub>		Drain "Miller" Charge		6 4 MUL	(11018 4)	-	14	-	nC
ESR	Equival	ent Series Resistance	)	f = 1 MHz		-	1	-	Ω
Switching	Charac	teristics							
t <sub>d(on)</sub>	Turn-Or	n Delay Time		$V_{DD} = 380 \text{ V}, \text{ I}_{D} = 14 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{g} = 4.7 \Omega$ (Note 4)		-	25	60	ns
t <sub>r</sub>	Turn-Or	n Rise Time				-	16	42	ns
t <sub>d(off)</sub>	Turn-Of	f Delay Time				-	65	140	ns
t <sub>f</sub>	Turn-Of	f Fall Time				-	4	18	ns
Drain-Sou	rce Dioc	de Characteristic	cs						
Is	Maximum Continuous Drain to Source Diode Forward Current			-	-	28	Α		
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current			-	-	84	Α		
V <sub>SD</sub>	Drain to	Source Diode Forwar	rd Voltage	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 14 A		-	-	1.2	V
t <sub>rr</sub>	Reverse	e Recovery Time		$V_{GS} = 0 V, I_{SD} = 14 A,$ $dI_F/dt = 100 A/\mu s$		-	376	-	ns
Q <sub>rr</sub>	Reverse	Recovery Charge				-	7.6	-	μC

1. Repetitive rating: pulse width limited by maximum junction temperature.

2. I<sub>AS</sub> = 6 A, V<sub>DD</sub> = 50 V, R<sub>G</sub> = 25  $\Omega$ , starting T<sub>J</sub> = 25°C.

3. I\_{SD}  $\leq$  14 A, di/dt  $\leq$  200 A/µs, V\_{DD}  $\leq$  BV\_{DSS}, starting T\_J = 25°C.

4. Essentially independent of operating temperature typical characteristics.

6

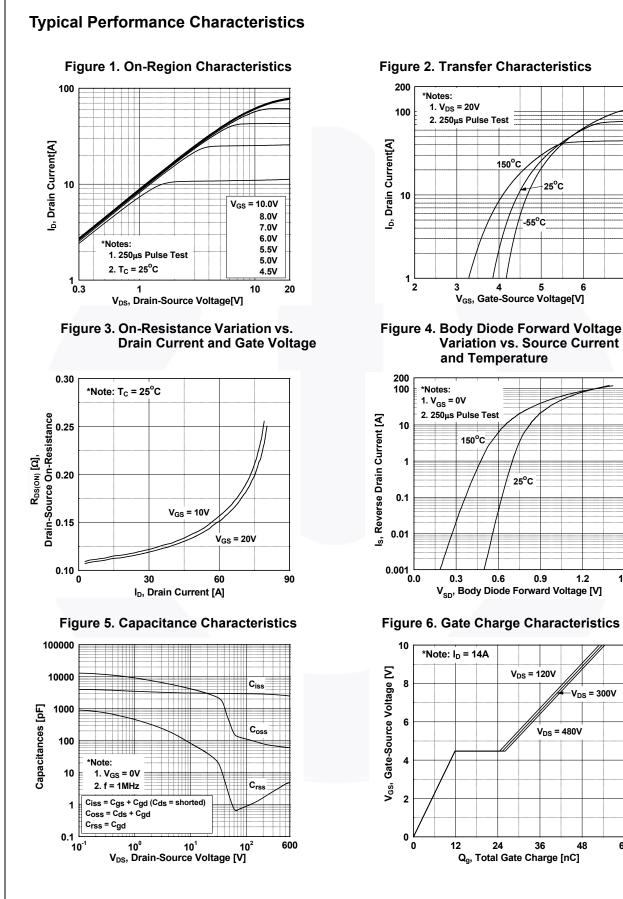
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-V<sub>DS</sub> = 300V

48

1.5

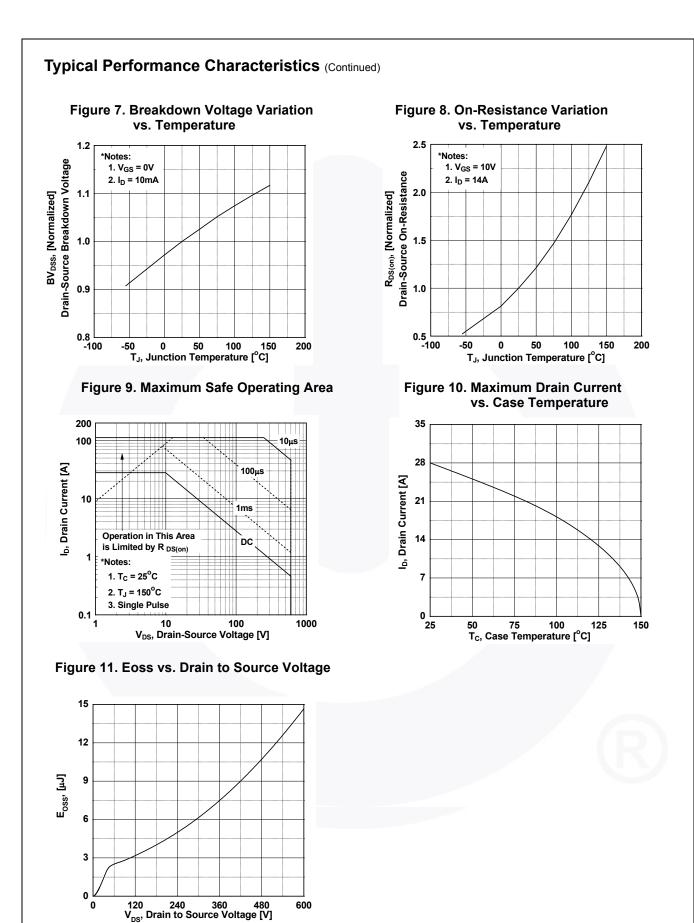
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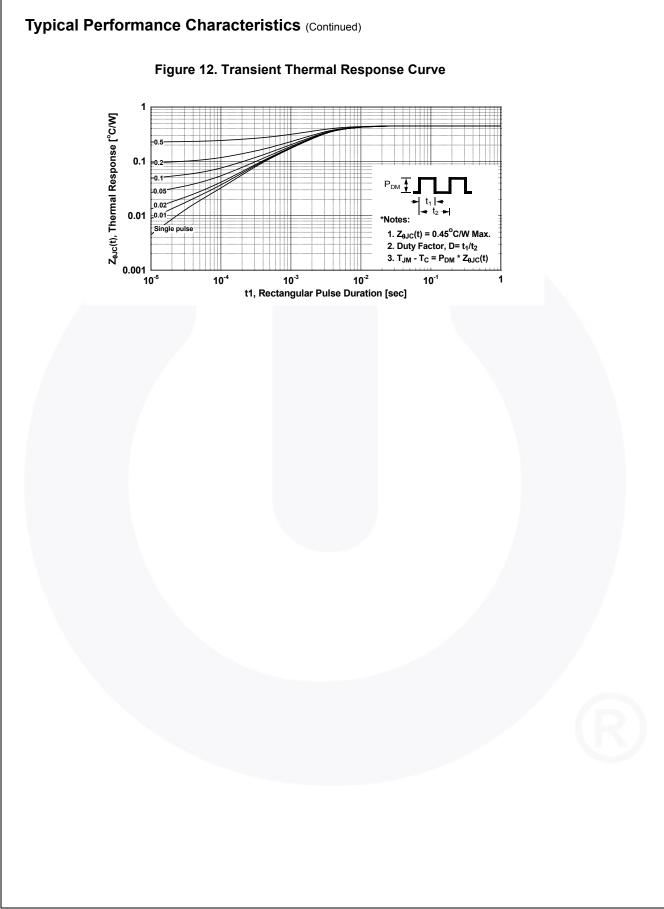


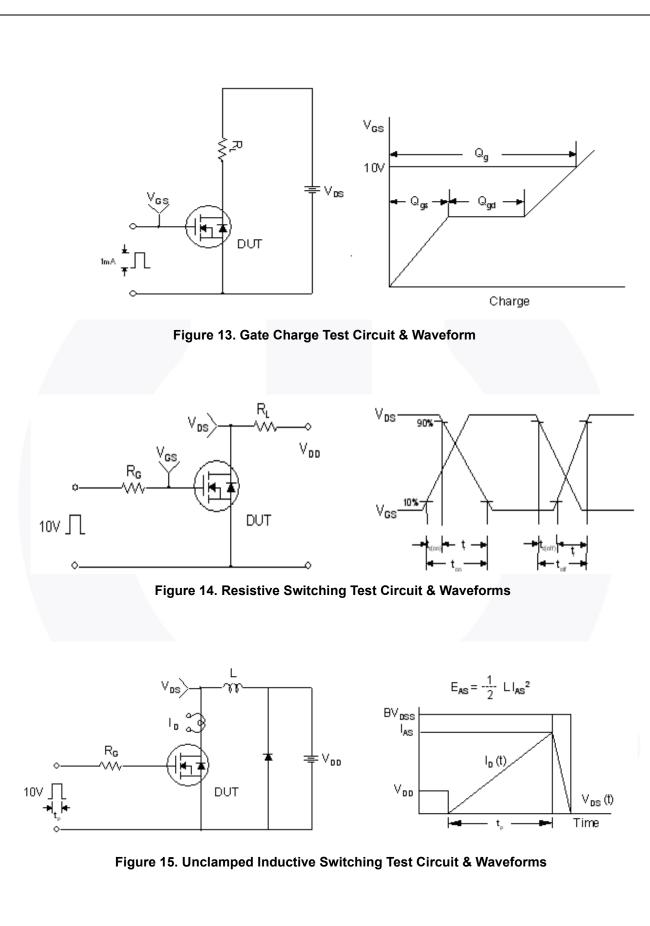
#### **Figure 2. Transfer Characteristics**

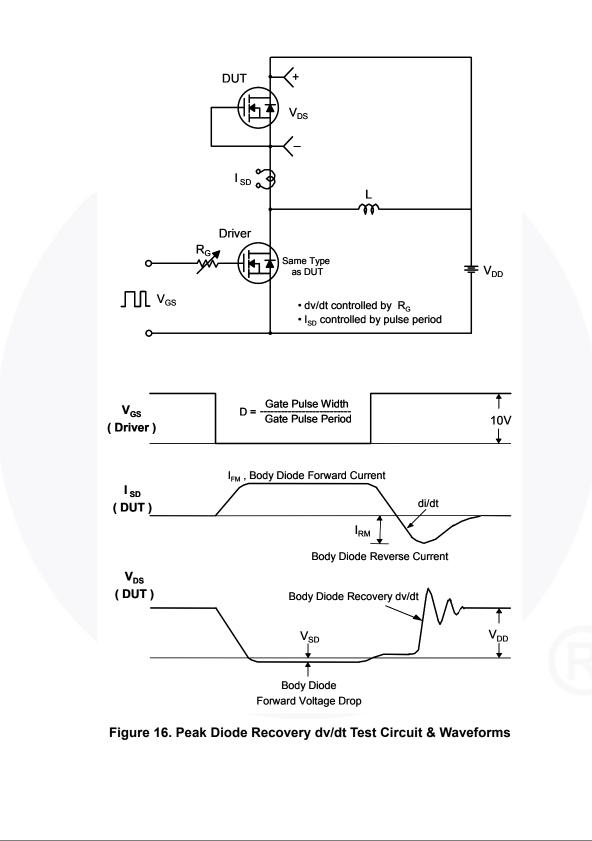
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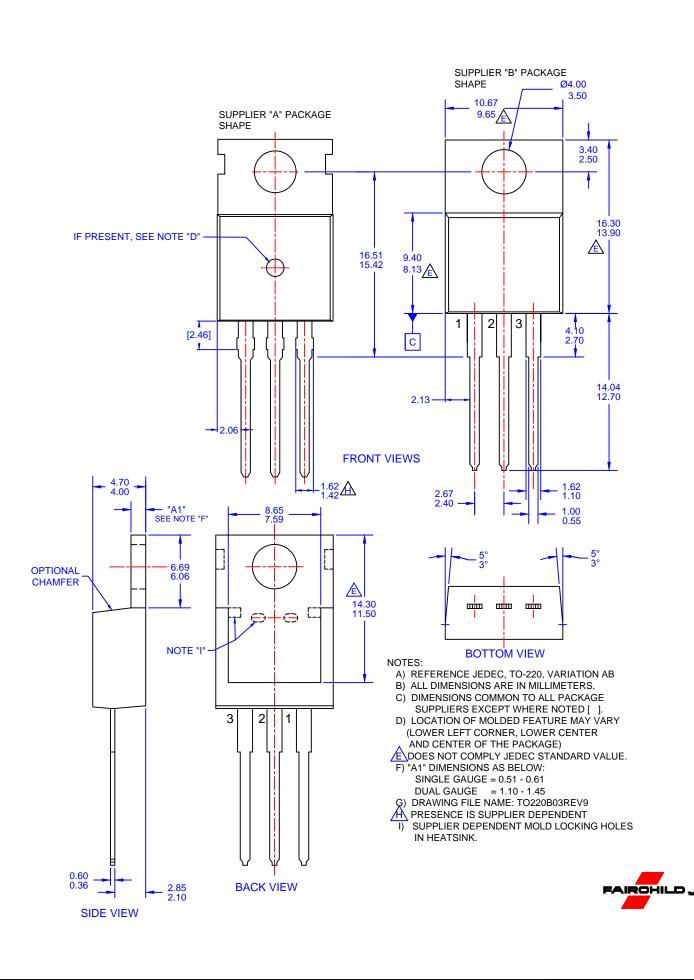
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